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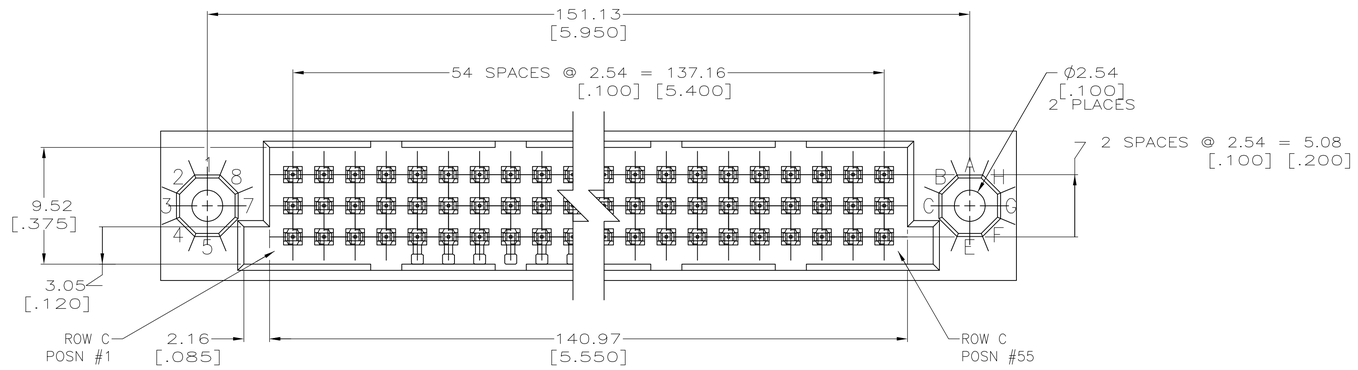
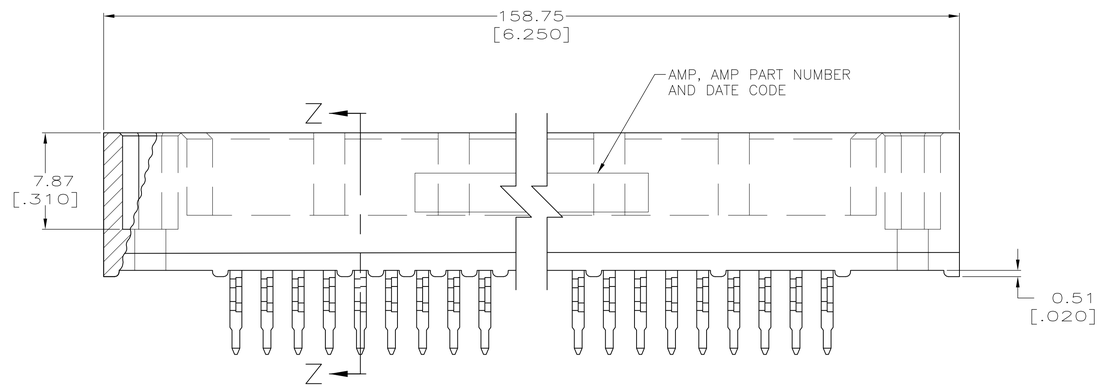
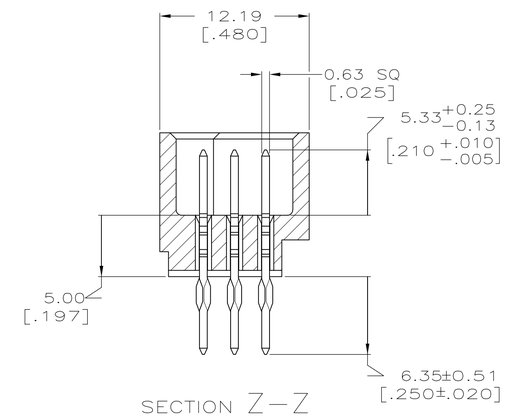
REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
	C	REVISED PER ECO-15-015252	13NOV15	BJ	FY

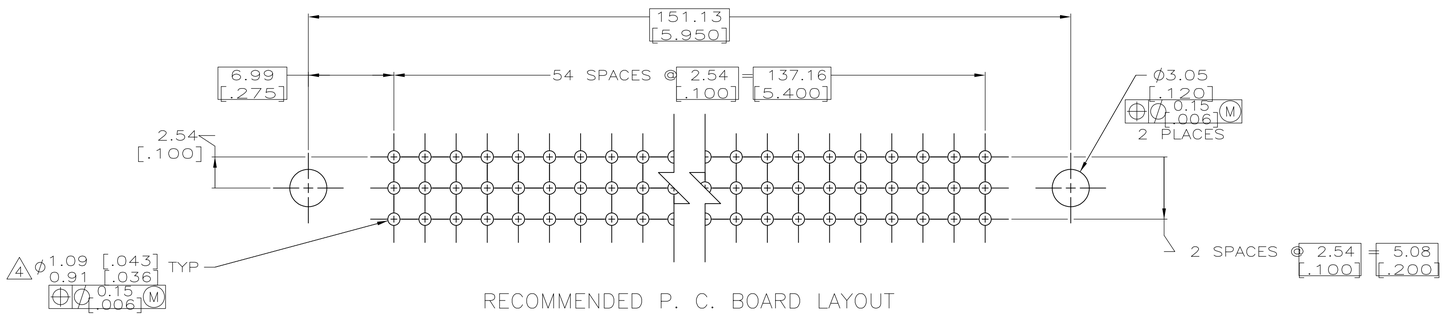


1. HOUSING MATERIAL: THERMOPLASTIC, BLACK.
2. HOUSING MATERIAL: THERMOPLASTIC, COLOR-NATURAL.
3. FINISH:
   MATING AREA: MEETS THE PERFORMANCE REQUIREMENTS OF PRODUCT SPECIFICATION 108-9063; BASED ON TELCORDIA DR-1217-CORE APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
   SOLDER TAILS AREA: TIN-LEAD PLATED.
4. ACTION PIN POSTS REQUIRE 2.36 [.093] MIN THICK P.C. BOARD. RECOMMENDED P.C. BOARD HOLES ARE 1.151 [.0453] DIA PLATED THRU WITH 0.025-0.076 [.001-.003] COPPER, WITH 0.0076 [.0003] MIN TIN-LEAD PLATING; FINISHED HOLE AFTER PLATING 0.94-1.09 [.037-043] DIA.





SECTION Z-Z



RECOMMENDED P. C. BOARD LAYOUT

| NUMBER END | | |

单击下面可查看定价，库存，交付和生命周期等信息

>>TE Connectivity(泰科)

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